

N-channel SiC power MOSFET

| V_{DSS} | 1700V |
|----------------------------|-------|
| R _{DS(on)} (Typ.) | 1.15Ω |
| I _D | 3.7A |
| P_{D} | 35W |

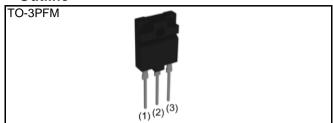
Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Long creepage distance
- 4) Simple to drive
- 5) Pb-free lead plating; RoHS compliant

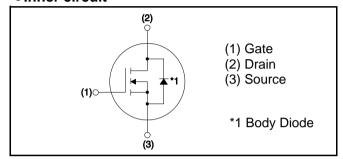
Application

- Auxilialy power supplies
- Switch mode power supplies

Outline



•Inner circuit



Packaging specifications

| or ackaging specifications | | | | |
|----------------------------|---------------------------|-----------|--|--|
| | Packing | Tube | | |
| | Reel size (mm) | - | | |
| Type | Tape width (mm) | - | | |
| Туре | Basic ordering unit (pcs) | 30 | | |
| | Taping code | C11 | | |
| | Marking | SCT2H12NZ | | |

● **Absolute maximum ratings** (T_{vi} = 25°C unless otherwise spesified)

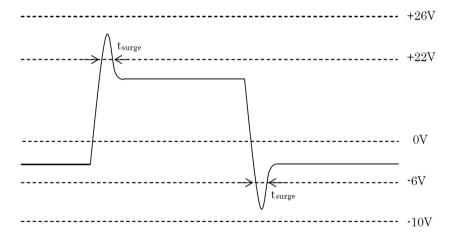
| Parameter | | Symbol | Value | Unit |
|---|------------------------|---------------------------|-------------|------|
| Drain - Source voltage | | V _{DSS} | 1700 | V |
| Continuous drain current | T _c = 25°C | I _D *1 | 3.7 | А |
| Continuous drain current | T _c = 100°C | I _D *1 | 2.6 | А |
| Pulsed drain current | | I _{D,pulse} *2 | 9.2 | А |
| Gate - Source voltage (DC) | | V_{GSS} | -6 to 22 | V |
| Gate - Source surge voltage (t _{surge} <300nsec) | | V _{GSS_surge} *3 | -10 to 26 | V |
| Power dissipation (T _c = 25°C) | | P _D | 35 | W |
| Virtual Junction temperature | | T _{vj} | 175 | °C |
| Range of storage temperature | | T_{stg} | -55 to +175 | °C |

●Electrical characteristics (T_{vj} = 25°C unless otherwise spesified)

| Parameter | Symbol | Conditions | Values | | | Unit |
|------------------------------------|-------------------|--|--------|------------|------|-------|
| Farameter | Symbol | Conditions | Min. | Тур. | Max. | Offic |
| Drain - Source breakdown voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V$, $I_D = 1mA$ | 1700 | - | - | V |
| Zero gate voltage drain current | I _{DSS} | $V_{DS} = 1700V, V_{GS} = 0V$ $T_{vj} = 25^{\circ}C$ $T_{vj} = 150^{\circ}C$ | - | 0.1 0.2 | 10 | μА |
| Gate - Source leakage current | I _{GSS+} | $V_{GS} = +22V, V_{DS} = 0V$ | - | - | 100 | nA |
| Gate - Source leakage current | I _{GSS-} | $V_{GS} = -6V$, $V_{DS} = 0V$ | - | - | -100 | nA |
| Gate threshold voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_{D} = 0.41 \text{mA}$ | 1.6 | 2.8 | 4.0 | V |

^{*1} Limited by maximum $T_{\nu j}$ and for Max. $R_{thJC}.$

^{*3} Example of acceptable V_{GS} waveform



*4 Pulsed

^{*2} PW \leq 10 μ s, Duty cycle \leq 1%

•Electrical characteristics ($T_{vj} = 25$ °C unless otherwise spesified)

| Doromotor | Symbol Conditions - | | Values | | | l lm:t |
|--|------------------------|---|--------|------|------|--------|
| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
| | | $V_{GS} = 18V, I_D = 1.1A$ | | | | |
| Static drain - source on - state resistance | R _{DS(on)} *4 | T _{vj} = 25°C | - | 1.15 | 1.50 | Ω |
| | | T _{vj} = 125°C | - | 1.71 | - | |
| Gate input resistance | R_{G} | f = 1MHz, open drain | - | 64 | - | Ω |
| Transconductance | g _{fs} *4 | $V_{DS} = 10V, I_D = 1.1A$ | - | 0.4 | - | S |
| Input capacitance | C _{iss} | $V_{GS} = 0V$ | - | 184 | - | |
| Output capacitance | C _{oss} | V _{DS} = 800V | - | 16 | - | pF |
| Reverse transfer capacitance | C _{rss} | f = 1MHz | - | 6 | - | |
| Effective output capacitance, energy related | C _{o(er)} | $V_{GS} = 0V$ $V_{DS} = 0V$ to 800V | - | 17 | - | pF |
| Turn - on delay time | t _{d(on)} *4 | $V_{DD} = 500V, I_D = 1.1A$ | - | 16 | - | |
| Rise time | t _r *4 | V _{GS} = 18V/0V | - | 21 | - | |
| Turn - off delay time | t _{d(off)} *4 | $R_L = 455\Omega$ | - | 35 | - | ns |
| Fall time | t _f *4 | $R_G = 0\Omega$ | - | 74 | - | |
| Turn - on switching loss | E _{on} *4 | $V_{DD} = 800V, I_{D} = 1.1A$ $V_{GS} = 18V/0V$ | - | 57 | - | 1 |
| Turn - off switching loss | E _{off} *4 | R _G = 0Ω, L=2mH *E _{on} includes diode reverse recovery | - | 32 | - | μJ |

● Gate Charge characteristics (T_{vj} = 25°C unless otherwise spesified)

| Parameter | Symbol | Conditions | Values | | | Unit |
|----------------------|------------------------|---------------------------|--------|------|------|-------|
| Farameter | Symbol | Conditions | Min. | Тур. | Max. | Offic |
| Total gate charge | Q_g^{*4} | V _{DD} = 500V | - | 14 | - | |
| Gate - Source charge | Q _{gs} *4 | I _D = 1A | - | 4 | ı | nC |
| Gate - Drain charge | ${\sf Q_{gd}}^{^{*4}}$ | V _{GS} = 18V | - | 5 | - | |
| Gate plateau voltage | $V_{(plateau)}$ | $V_{DD} = 500V, I_D = 1A$ | - | 10.5 | - | V |

●Body diode electrical characteristics (Source-Drain) (T_{vj} = 25°C unless otherwise spesified)

| Parameter | Symbol | Conditions | Values | | | Unit |
|---|---------------------|---|--------|------|------|-------|
| raiametei | Symbol | Conditions | Min. | Тур. | Max. | Offic |
| Inverse diode continuous, forward current | l _S *1 | ·T _c = 25°C | - | 1 | 3.7 | А |
| Inverse diode direct current, pulsed | I _{SM} *2 | | - | - | 9.2 | А |
| Forward voltage | V _{SD} *4 | $V_{GS} = 0V, I_{S} = 1.1A$ | - | 4.3 | - | V |
| Reverse recovery time | t _{rr} *4 | | - | 21 | - | ns |
| Reverse recovery charge | Q _{rr} *4 | $I_F = 1.1A, V_R = 800V$ di/dt = 300A/ μ s | - | 13 | - | nC |
| Peak reverse recovery current | I _{rrm} *4 | | - | 1.1 | - | Α |

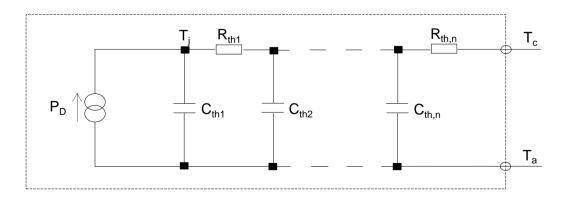
●Thermal resistance

| Parameter | Symbol | Values | | | Unit |
|-------------------------------------|------------|--------|------|------|-------|
| Parameter | | Min. | Тур. | Max. | UTIIL |
| Thermal resistance, junction - case | R_{thJC} | - | 3.32 | 4.32 | K/W |

●Typical Transient Thermal Characteristics

| Symbol | Value | Unit |
|------------------|-------|------|
| R _{th1} | 816m | |
| R _{th2} | 1939m | K/W |
| R _{th3} | 567m | |

| Symbol | Value | Unit |
|------------------|-------|------|
| C _{th1} | 127μ | |
| C _{th2} | 1.64m | Ws/K |
| C _{th3} | 64.5m | |



TSQ50231-SCT2H12NZ

14.Apr.2023 - Rev.002

Fig.1 Power Dissipation Derating Curve

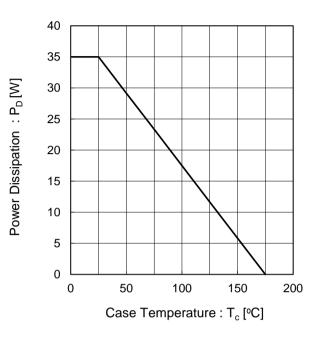


Fig.2 Maximum Safe Operating Area

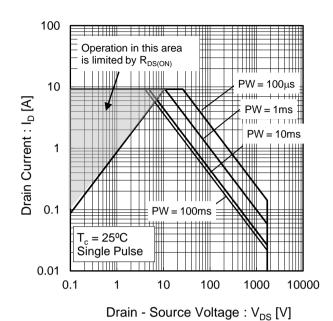


Fig.3 Typical Transient Thermal Impedance vs. Pulse Width

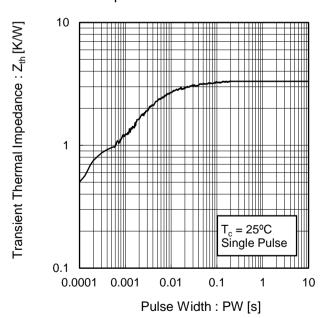


Fig.4 Typical Output Characteristics(I)

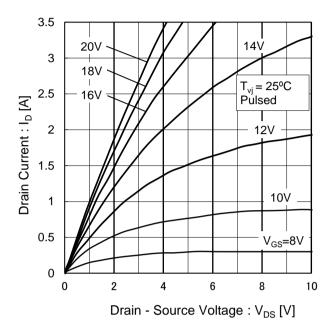


Fig.5 Typical Output Characteristics(II)

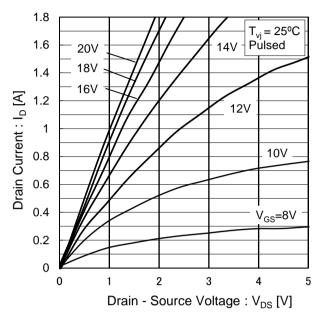
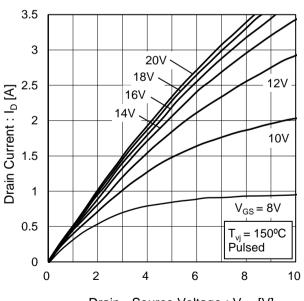
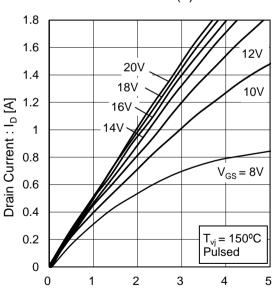


Fig.6 T_{vj} = 150°C Typical Output Characteristics(I)



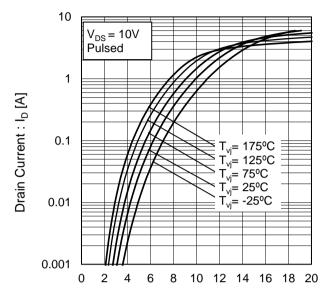
Drain - Source Voltage : V_{DS} [V]

Fig.7 T_{vj} = 150°C Typical Output Characteristics(II)



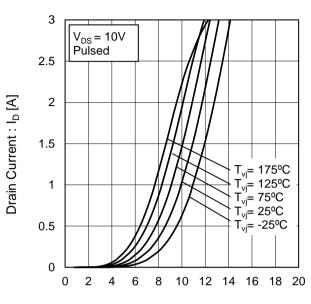
Drain - Source Voltage : V_{DS} [V]

Fig.8 Typical Transfer Characteristics (I)



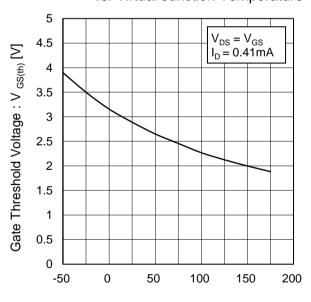
Gate - Source Voltage : V_{GS} [V]

Fig.9 Typical Transfer Characteristics (II)



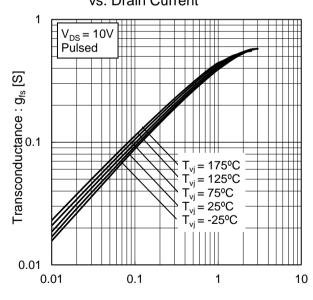
Gate - Source Voltage : V_{GS} [V]

Fig.10 Gate Threshold Voltage vs. Virtual Junction Temperature



Virtual Junction Temperature : T_{vi} [°C]

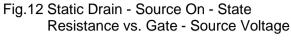
Fig.11 Transconductance vs. Drain Current

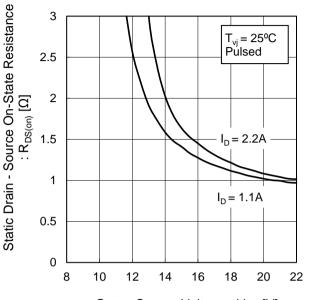


Drain Current : I_D [A]

200

• Electrical characteristic curves





Gate - Source Voltage : V_{GS} [V]

Resistance vs. Virtual Junction Temperature CD_{Out} $CD_{$

50

0

-50

0

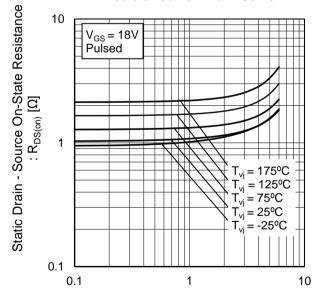
Fig.13 Static Drain - Source On - State

Virtual Junction Temperature : T_{vj} [°C]

100

150

Fig.14 Static Drain - Source On - State Resistance vs. Drain Current



Drain Current : I_D [A]

Fig.15 Typical Capacitance vs. Drain - Source Voltage

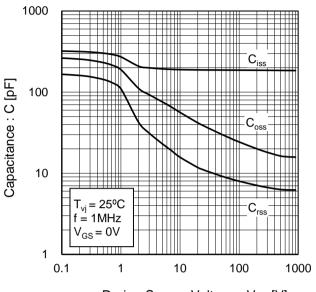
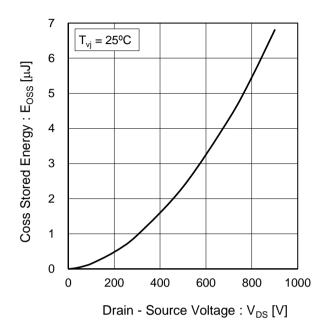
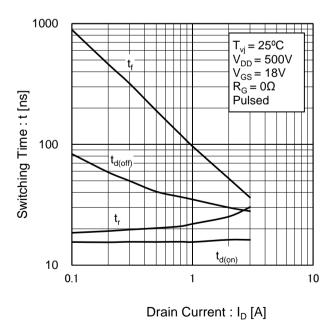


Fig.16 Coss Stored Energy



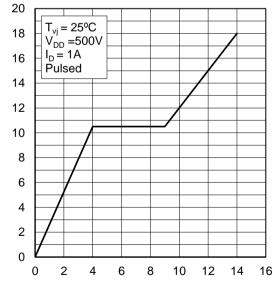
Drain - Source Voltage : V_{DS} [V]

Fig.17 Switching Characteristics



Gate - Source Voltage : V_{GS} [V]

Fig.18 Dynamic Input Characteristics



Total Gate Charge : Q_q [nC]

Fig.19 Typical Switching Loss vs. Drain - Source Voltage

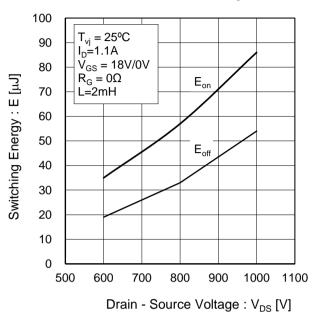


Fig.20 Typical Switching Loss vs. Drain Current

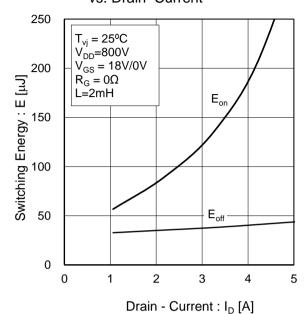
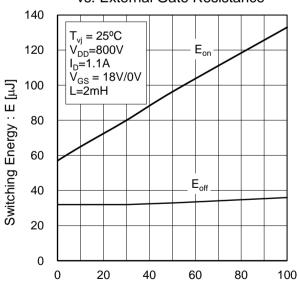
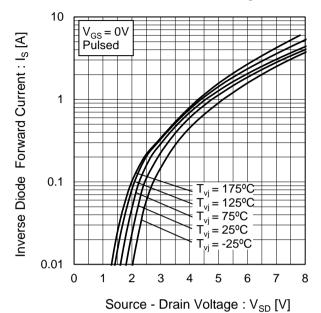


Fig.21 Typical Switching Loss vs. External Gate Resistance



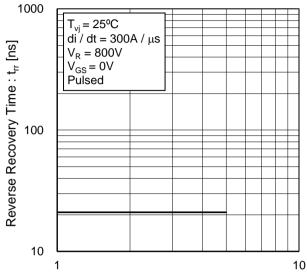
External Gate Resistance : R_G [Ω]

Fig.22 Inverse Diode Forward Current vs. Source - Drain Voltage



vs.Inverse Diode Forward Current

Fig.23 Reverse Recovery Time



Inverse Diode Forward Current : I_S [A]

Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

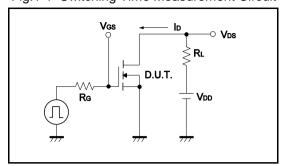


Fig.2-1 Gate Charge Measurement Circuit

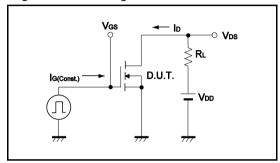


Fig.3-1 Switching Energy Measurement Circuit

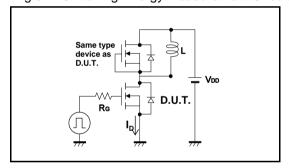


Fig.4-1 Reverse Recovery Time Measurement Circuit Fig.4-2 Reverse Recovery Waveform

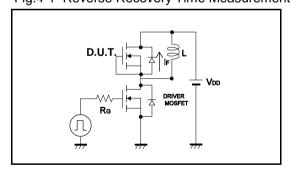


Fig.1-2 Switching Waveforms

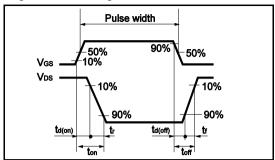


Fig.2-2 Gate Charge Waveform

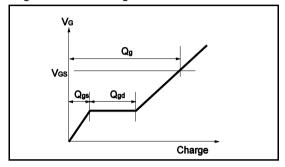
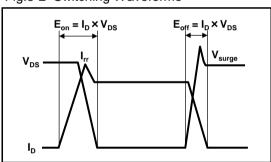
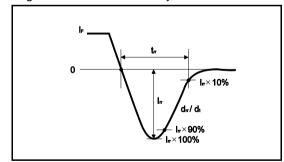


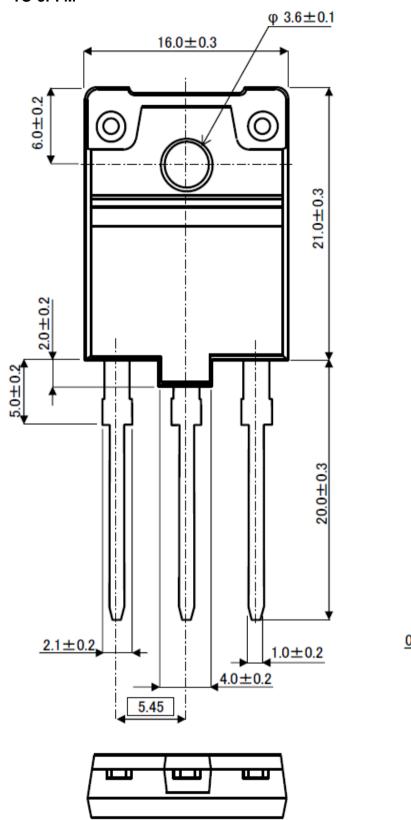
Fig.3-2 Switching Waveforms

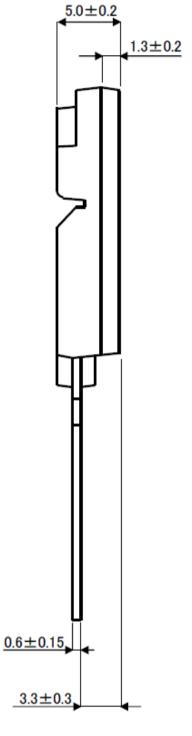




●Package Dimensions

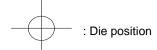
TO-3PFM

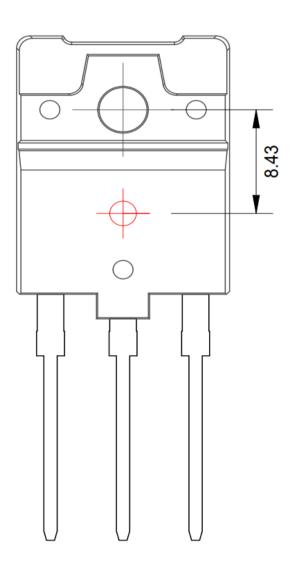




UNIT:mm

●Die Bonding Layout





- · Front view of the packaging.
- · Dimensions are design values.
- · If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm

Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications.
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.

 Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products specified in this document are not designed to be radiation tolerant.
- 7) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative: transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, and power transmission systems.
- 8) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 9) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
- 10) ROHM has used reasonable care to ensure the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
- 11) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
- 12) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
- This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/

General Precaution

- 1. Before you use our Products, you are requested to carefully read this document and fully understand its contents. ROHM shall not be in any way responsible or liable for failure, malfunction or accident arising from the use of any ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this document is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sales representative.
- 3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate and/or error-free. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

Notice – WE Rev.001